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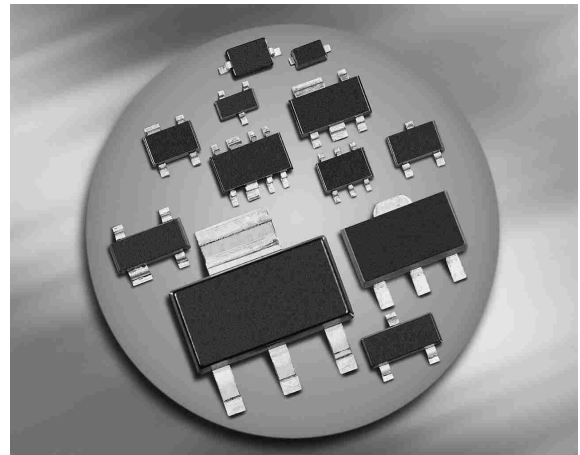
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Multi-Channel TVS Diode Array

- ESD / transient protection of data and power lines in 3.3 V / 5 V application according to:
IEC61000-4-2 (ESD): ± 30 KV (contact)
IEC61000-4-4 (EFT): 80 A (5/50 ns)
IEC61000-4-5 (Surge): 10 A (8/20 μ s)
- Working voltage: 5 V (5.3 V max.)
- Low clamping voltage
- Low reverse current $< 5 \mu$ A
- Pb-free (RoHS compliant) package

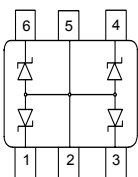


Applications

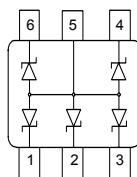
- Uni or bi-directional operation possible (see application example page 5)
- Mobile communication
- Consumer products (STB, MP3, DVD, DSC...)
- LCD displays, camera
- Notebooks and desktop computers, peripherals



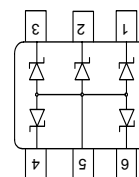
ESD5V0S4US



ESD5V0S5US



ESD5V0S5US E6727
180° rotated in reel



| Type | Package | Configuration | Marking |
|-------------------|---------|--------------------------|------------|
| ESD5V0S4US | SOT363 | 4 lines, uni-directional | E4s |
| ESD5V0S5US | SOT363 | 5 lines, uni-directional | E5s |
| ESD5V3S5US E6727* | SOT363 | 5 lines, uni-directional | on request |

* Preliminary data

Maximum Ratings at $T_A = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Value | Unit |
|---|------------------|-----------|------|
| ESD contact discharge per diode ¹⁾ | V_{ESD} | 30 | kV |
| Peak pulse current ($t_p = 8 / 20 \mu\text{s}$) per diode ²⁾ | I_{pp} | 10 | A |
| Peak pulse power ($t_p = 8 / 20 \mu\text{s}$) per diode | P_{pk} | 130 | W |
| Operating temperature range | T_{op} | -55...125 | °C |
| Storage temperature | T_{stg} | -65...150 | |

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit |
|-----------|--------|--------|------|------|------|
| | | min. | typ. | max. | |

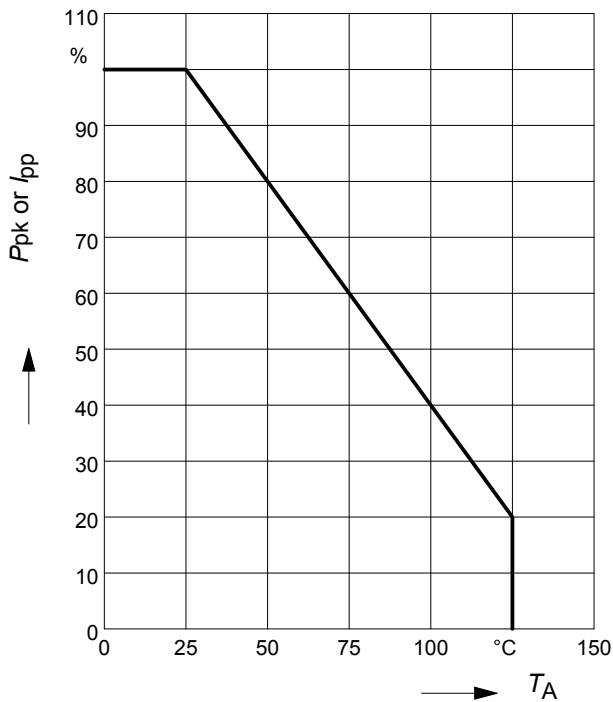
Characteristics -

| | | | | | |
|---|-------------------|-----|------|-----|---------------|
| Reverse working voltage | V_{RWM} | - | 5 | 5.3 | V |
| Breakdown voltage $I_{(\text{BR})} = 1 \text{ mA}$ | $V_{(\text{BR})}$ | 5.7 | 6.7 | 7.7 | |
| Reverse current $V_R = 3.3 \text{ V}$ $V_R = 5 \text{ V}$ | I_R | - | - | 1 | μA |
| | | - | - | 5 | |
| Clamping voltage (positive transients) $I_{\text{PP}} = 1 \text{ A}, t_p = 8/20 \mu\text{s}^2$ $I_{\text{PP}} = 10 \text{ A}, t_p = 8/20 \mu\text{s}^2$ | V_{CL} | - | 7 | 9 | V |
| | | - | 10.5 | 13 | |
| Forward clamping voltage (negative transients) $I_{\text{PP}} = 1 \text{ A}, t_p = 8/20 \mu\text{s}^2$ $I_{\text{PP}} = 10 \text{ A}, t_p = 8/20 \mu\text{s}^2$ | V_{FC} | - | 1 | 3 | |
| | | - | 3.5 | 6 | |
| Diode capacitance $V_R = 0 \text{ V}, f = 1 \text{ MHz}$ $V_R = 5 \text{ V}, f = 1 \text{ MHz}$ | C_T | - | 70 | 90 | pF |
| | | - | 35 | 55 | |

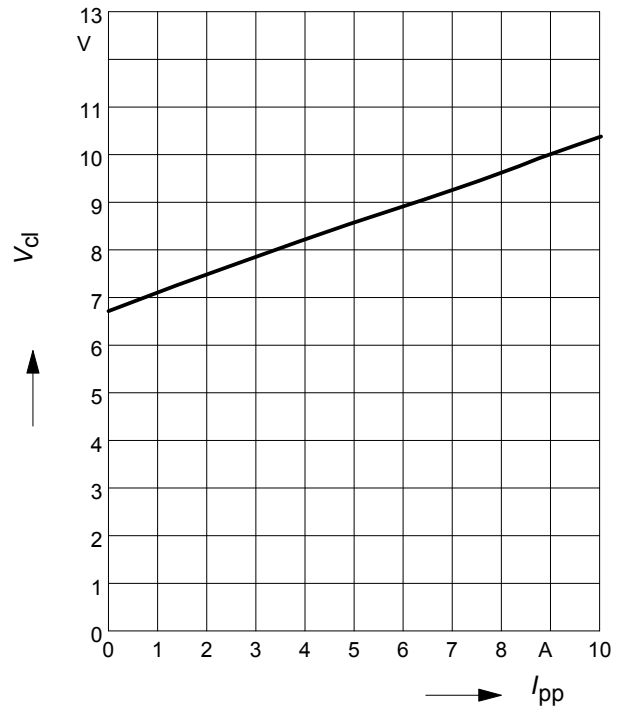
¹⁾ V_{ESD} according to IEC61000-4-2

²⁾ I_{pp} according to IEC61000-4-5

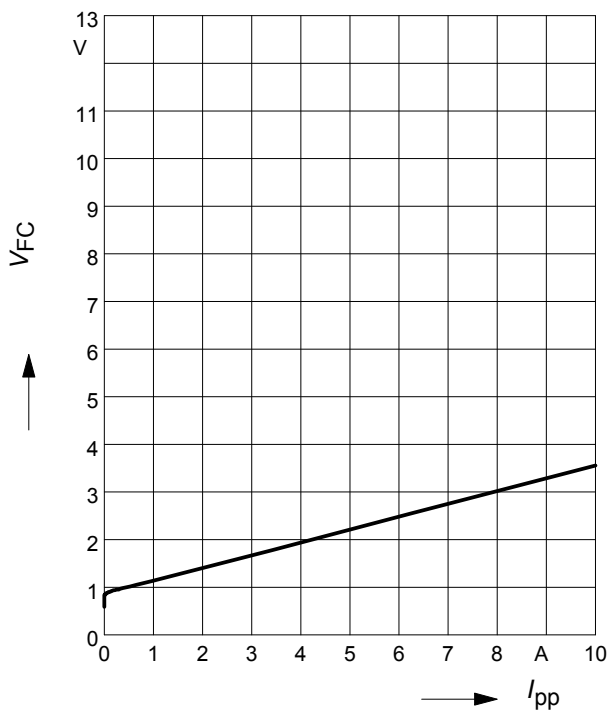
Power derating curve $P_{pk} = f(T_A)$



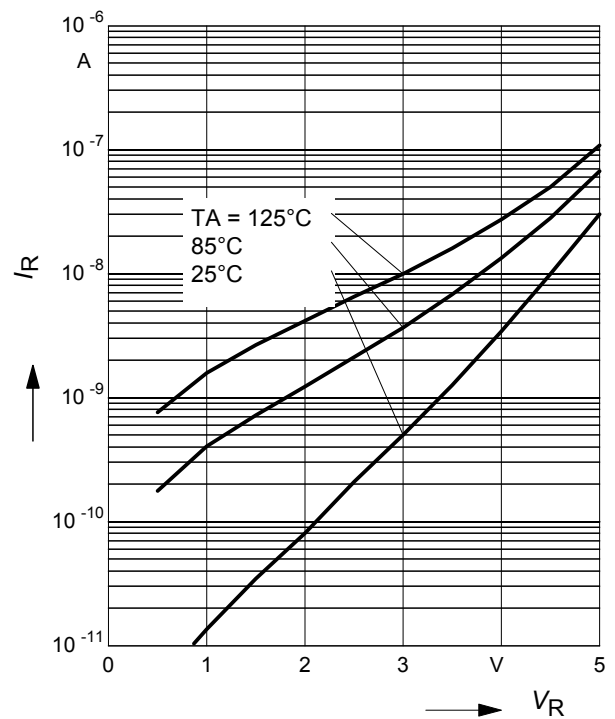
Clamping voltage, $V_{cl} = f(I_{pp})$
 $t_p = 8 / 20 \mu s$ (positive transients)



Forward clamping voltage $V_{FC} = f(I_{pp})$
 $t_p = 8 / 20 \mu s$ (negative transients)



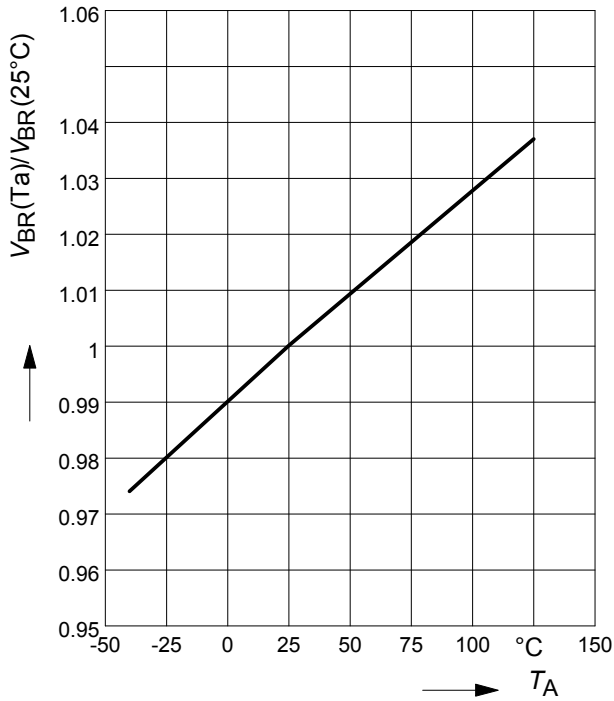
Reverse current $I_R = f(V_R)$
 $T_A = \text{Parameter}$



Normalized reverse voltage

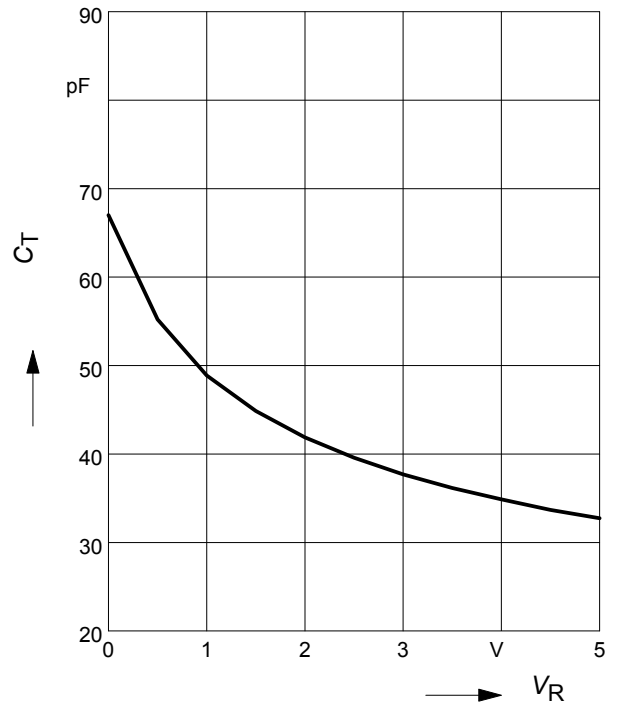
$$V_{BR}(T_A)/V_{BR}(25^\circ\text{C}) = f(T_A)$$

$$I_R = 1 \text{ mA}$$



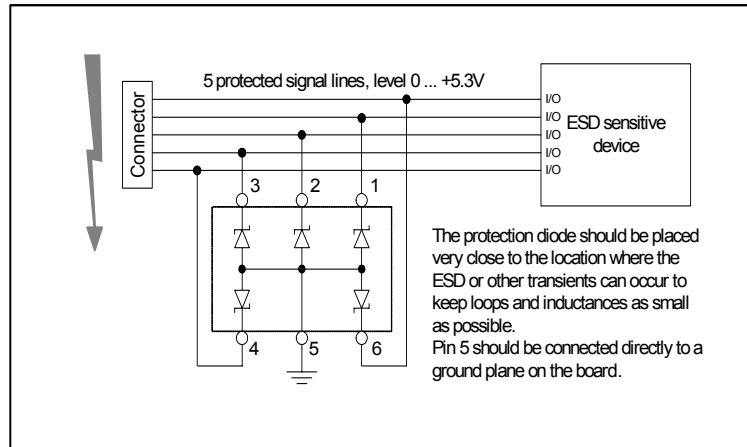
Diode capacitance $C_T = f(V_R)$

$$f = 1 \text{ MHz}$$



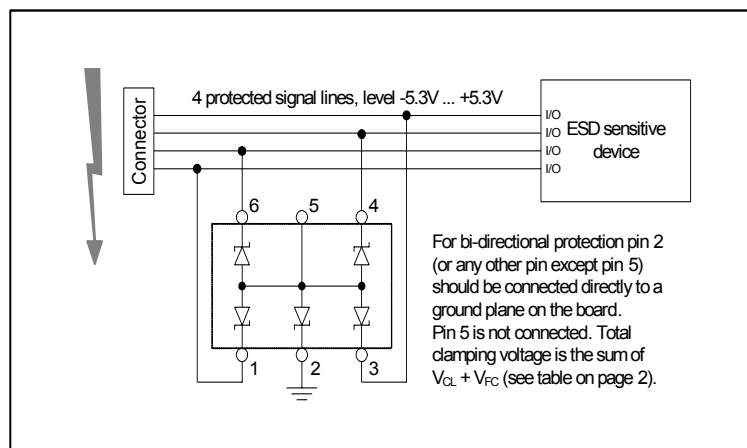
Application example ESD5V0S5US

5 channels, uni-directional



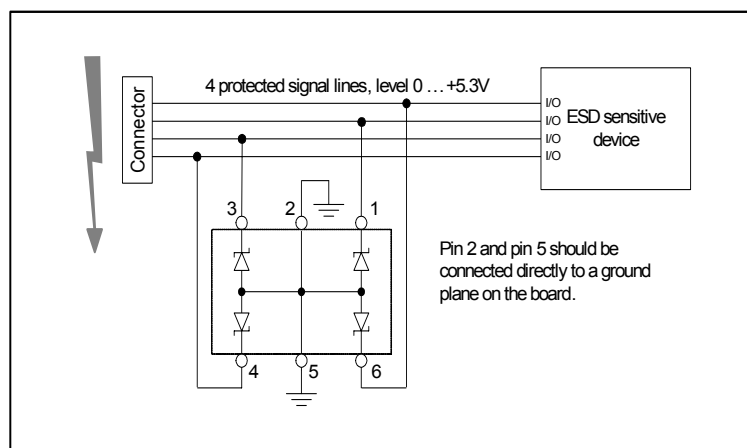
Application example ESD5V0S5US

4 channels, bi-directional

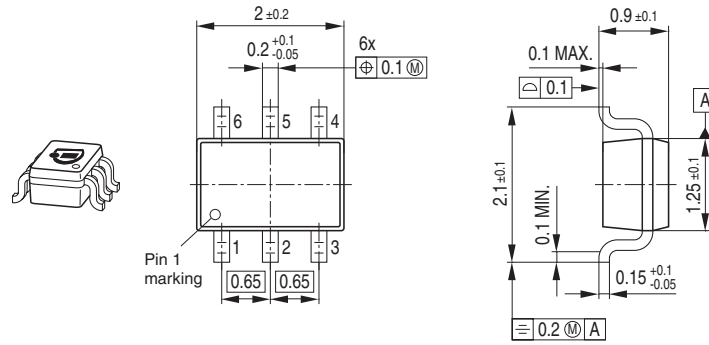


Application example ESD5V0S4US

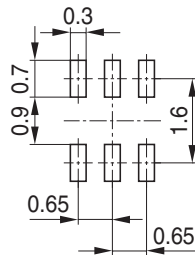
4 channels, uni-directional



Package Outline

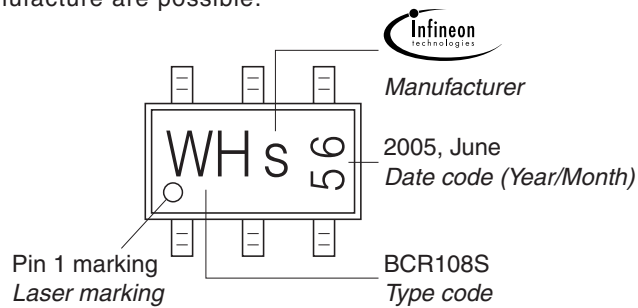


Foot Print



Marking Layout (Example)

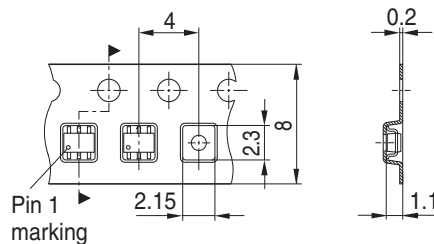
Small variations in positioning of Date code, Type code and Manufacture are possible.



Standard Packing

Reel \varnothing 180 mm = 3.000 Pieces/Reel
 Reel \varnothing 330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.



Edition 2009-11-16

**Published by
Infineon Technologies AG
81726 Munich, Germany**

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